



# AND520HG

## **GaN High Brightness Green Light Emission**

- 5 mm (T1-3/4) Package
- Peak wavelength (lp = 540nm) high bright emission
- · All plastic mold type, clear colorless lens
- Low drive current: 1 to 20 mA DC
- Excellent On-Off contrast ratio
- · Fast response time, capable of pulse operation
- High power intensity suitable for Outdoor Message Signboards
- · High reliability

### Maximum Ratings $(T_a = 25^{\circ}C)$

Characteristics	Symbol	Rating	Unit
Forward Current	I <sub>F</sub>	30	mA
Reverse Voltage	V <sub>R</sub>	5	V
Power Dissipation	P <sub>D</sub>	120	mW
Operating Temperature Range	T <sub>Opr</sub>	-40 to 85	С
Storage Temperature Range	T <sub>Sig</sub>	-40 to 100	С

### Electro-Optical Characteristics ( $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	$V_{F}$	I <sub>F</sub> = 20 mA	_	3.5	4.0	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5V	_	_	10	μA
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> = 20 mA	_	5,000		mcd
Peak Emission Wavelength	l <sub>P</sub>	I <sub>F</sub> = 20 mA	_	540	_	nm
Spectral Line Half Width	ΔΙ	I <sub>F</sub> = 20 mA	_	45	_	nm
Dominant Wavelength	ld	I <sub>F</sub> = 20 mA	520	_	550	nm
Full Viewing Angle	q	I <sub>V</sub> = 1/2 Peak	_	20	_	degree

#### Precaution

Please be careful of the following:

- 1. Soldering temperature: 260 C max.
  - Soldering time: 5 sec. max.
  - Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.
- 3. Absolute secure counter measures against static electricity and surge should be taken when handling these products. It is recommended to use wrist band or antistatic gloves when handling these LEDs.















